

# PTC thermistors

Series/Type: C1098, C1084, C1172, B59173, B59184, B59183

The following products presented in this data sheet are being withdrawn.

Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B59172C1130A151		2019-03-01	2019-06-07	2019-09-07
B59098C1100B051		2019-03-01	2019-06-07	2019-09-07
B59084C1080B140		2019-03-01	2019-06-07	2019-09-07



Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B59173C1130A151		2021-02-19	2021-05-28	2021-08-27
B59184C1120B153		2021-02-19	2021-05-28	2021-08-27
B59183C1160A140		2021-02-19	2021-05-28	2021-08-27

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### Leaded disks

### **Applications**

- Overcurrent protection for telecom applications
- Suitable for line card applications e.g. POTS, access networks, customer premises equipment (CPE) or integrated voice data (IVD)

#### **Features**

- Compliant with ITU-T standards
  - basic-level lightning surges (10/700 μs)
  - basic-level power induction (600 V, 1 A, 0.2 s)
  - power contact criteria A/B (230 V, 15 min.)
- Matching available with narrow resistance tolerance
- Tight resistance matching maintained after switching
- Negligible resistance drift after soldering or switching
- Marking: Type, manufacturer's logo, reference temperature in °C and date code YYWW
- UL approval to UL 1434 (file number E69802) for B59154U1135B140, B59184C1120B153 and B59184C1130A151
- RoHS-compatible

### **Options**

Alternative tolerances and resistances on request

### **Delivery mode**

- Taped on reel: Cardboard tape, 360-mm reel, taping to IEC 60286-2
- Bulk: In plastic bags

### General technical data

Maximum fault voltage <sup>1)</sup>		$V_{F,max}$	245	V AC
Max. operating voltage		$V_{max}$	135	V AC
Operating temperature range	(V = 0)	T <sub>op</sub>	-20/+125	°C
Operating temperature range	$(V = V_{max})$	Top	0/+70	°C

<sup>1)</sup> The maximum fault voltage V<sub>F,max</sub> is the highest voltage that is permitted to be applied across the PTC thermistor in protection mode.



## Leaded disks

# Electrical specifications and ordering codes

Туре	$R_R$	$\Delta R_R$	R <sub>25,match</sub>	I <sub>R</sub>	I <sub>R</sub>	Is	I <sub>Smax</sub>	Ordering code
			(per packing unit)	@	@	@		
			$ R_1 - R_2 _{max}$	25°C	70°C	25°C		
	Ω	%	Ω	mA	mA	mA	Α	
C1098	6	±17	No	185	110	440	3.0	B59098C1100B051
C1084	20.8	±20	1	80	40	240	3.0	B59084C1080B140
U1154	50	±15	1	65	45	150	2.5	B59154U1135B140
C1172	50	±15	3	95	63	250	2.0	B59172C1130A151
C1184	50	±15	1.0	90	60	190	2.5	B59184C1120B153
C1184	50	±15	1.0	100	60	210	2.5	B59184C1130A151
C1173	55	±15	3.0	90	60	210	2.5	B59173C1130A151
C1183	55	±15	3	115	90	270	3.0	B59183C1160A140

# Switching times and ordering codes

Туре	R <sub>R</sub>	t <sub>S</sub> (typ.) @ I <sub>Smax</sub>	t <sub>s</sub> (typ.) @ 1 A	t <sub>s</sub> (typ.) @ 500 mA	Ordering code
	Ω	s	s	s	
C1098	6	1.5	14.0	70.0	B59098C1100B051
C1084	20.8	0.06	0.5	2.0	B59084C1080B140
U1154	50	0.05	0.3	1.1	B59154U1135B140
C1172	50	0.25	1.7	6.0	B59172C1130A151
C1184	50	0.06	0.8	3.1	B59184C1120B153
C1184	50	0.08	1.1	4.0	B59184C1130A151
C1173	55	0.09	1.3	5.0	B59173C1130A151
C1183	55	0.25	2.3	9.0	B59183C1160A140



### Leaded disks

## Dimensional drawings 1)

Figure 1

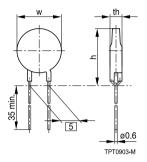
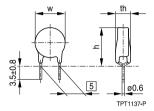


Figure 2



### Dimensions in mm

Туре	$R_R$	W <sub>max</sub>	h <sub>max</sub>	th <sub>max</sub>	Figure	Packaging	Ordering code
	Ω	mm	mm	mm			
C1098	6	13.0	17.0	5.0	Figure 1	Taped on reel	B59098C1100B051
C1084	20.8	7.5	4.0	10.5	Figure 2	Bulk	B59084C1080B140
U1154	50	6.0	10.0	4.0	Figure 2	Bulk	B59154U1135B140
C1172	50	8.0	11.0	5.5	Figure 1	Taped on reel	B59172C1130A151
C1184	50	9.0	12.5	4.5	Figure 1	Taped on reel	B59184C1120B153
C1184	50	9.0	13.0	4.5	Figure 1	Taped on reel	B59184C1130A151
C1173	55	8.0	11.0	5.5	Figure 1	Taped on reel	B59173C1130A151
C1183	55	9.5	13.0	6.0	Figure 2	Bulk	B59183C1160A140

<sup>1)</sup> The lead length stated in the dimensional drawing refers to the untaped version. For dimensions of the taped version, see chapter "Taping and packing".



## Leaded disks

# Reliability data

Test	Standard	Test conditions	$ \Delta R_{25}/R_{25} $
Electrical endurance,	IEC 60738-1	Room temperature, I <sub>Smax</sub> ; V <sub>max</sub>	< 20%
cycling		Number of cycles: 10	
Electrical endurance,	IEC 60738-1	Storage at $V_{max}$ and $T_{op,max}$ (@ $V_{max}$ )	< 25%
constant		Test duration: 1000 h	
Damp heat	IEC 60738-1	Temperature of air: 40 °C	< 10%
		Relative humidity of air: 93%	
		Duration: 56 days	
		Test according to IEC 60068-2-78	
Rapid change	IEC 60738-1	$T_1 = T_{op,min} (0 \text{ V}), T_2 = T_{op,max} (0 \text{ V})$	< 10%
of temperature		Number of cycles: 5	
		Test duration: 30 min	
		Test according to IEC 60068-2-14, test Na	
Vibration	IEC 60738-1	Frequency range: 10 to 55 Hz	< 5%
		Displacement amplitude: 0.75 mm	
		Test duration: $3 \times 2 \text{ h}$	
-		Test according to IEC 60068-2-6, test Fc	
Shock	IEC 60738-1	Acceleration: 400 m/s <sup>2</sup>	< 5%
		Pulse duration: 6 ms; $6 \times 5000$ pulses	
Climatic sequence	IEC 60738-1	Dry heat: $T = T_{op,max}(0 \text{ V})$	< 10%
		Test duration: 16 h	
		Damp heat first cycle	
		Cold: $T = T_{op,min} (0 \text{ V})$	
		Test duration: 2 h	
		Damp heat 5 cycles	
		Tests performed according to	
		IEC 60068-2-30	



### Leaded disks

## ITU performance overview and fault conditions

	Test no.	ITU K20		ITU K21	ITU K21		ITU K45	
		Basic test level	Enhanced test level	Basic test level	Enhanced test level	Basic test level	Enhanced test level	
Power induction	1	Α	Α	Α	Α	Α	Α	
	2	В	С	В	С	В	С	
Power contact	3	D	E	D	E	D	E	
Lightning surge	4	F	G	G	G	G	G	
	5	Н	Н	Н	I	Н	Н	

	Α	600 V AC, R = 600 Ω, t = 0.2 s, criteria A
Power induction	В	600 V AC, R = 600 $\Omega$ , t = 1.0 s, with GDT, criteria A
	С	1500 V AC, R = 200 $\Omega$ , t = 2.0 s, with GDT, criteria A
	D	230 V AC, t = 15 min, R = 10 1000 Ω, criteria B
Power contact	Е	230 V AC, t = 15 min, R = 10, 20, 40, 80, 1000 $\Omega$ , criteria B, R = 160, 300, 600 $\Omega$ , criteria A
	F	$V_{c(max)}$ = 1.0 kV, R = 25 $\Omega$ , t = 10/700 $\mu$ s, without GDT, criteria A
Lightning surge	G	$V_{c(max)} = 1.5$ kV, R = 25 $\Omega$ , t = 10/700 $\mu$ s, without GDT, criteria A
	Н	$V_{c(max)} = 4.0$ kV, R = 25 $\Omega$ , t = 10/700 $\mu$ s, with GDT, criteria A
	I	$V_{c(max)} = 6.0$ kV, R = 25 $\Omega$ , t = 10/700 $\mu$ s, with GDT, criteria A

Note: Use a GDT (gas discharge tube) with adequate electrical properties in order to ensure reliable operation at enhanced test levels (power induction, lightning surge).

Criteria A: no damage, function must be fulfilled.

Criteria B: no fire hazard.



## Leaded disks

### Additional tests and test conditions

# For type C1172:

Enhanced test condition to K.20 power induction	$_{AC}$ , R = 600 $_{\Omega}$ , t = 0.5 s, without GDT, criteria A (no damage, function must be fulfilled)
Enhanced test condition to K.20 single port, lightning	$V_{c(max)}$ = 2500 V, t = 1.2/50 μs, R = 2 Ω, without GDT, criteria A (no damage, function must be fulfilled) Number of cycles: 500

## For type C1173:

Enhanced test condition to K.20	600 $V_{AC}$ , R = 600 $\Omega$ , t = 0.5 s, without GDT, criteria A
power induction	(no damage, function must be fulfilled)
Enhanced test condition to K.20	$V_{c(max)} = 4 \text{ kV}$ , $t = 10/700 \mu s$ , $R = 40 \Omega$ , without GDT,
single port, lightning	criteria A (no damage, function must be fulfilled)

## For type C1183:

GR1089 Second level intra building AC power fault	120 V <sub>AC</sub> (50 Hz), short circuit current 25 A, t = 15 min, criteria A (no damage, function must be fulfilled)
Enhanced test condition to K.20 power induction	600 $V_{AC}$ , R = 600 $\Omega$ , t = 1 s, without GDT, criteria A (no damage, function must be fulfilled)
Enhanced test condition to K.20 single port, lightning	$V_{c(max)}$ = 4 kV, t = 10/700 $\mu$ s, R = 40 $\Omega$ , without GDT, criteria A (no damage, function must be fulfilled)

# For type C1184:

Enhanced test condition to K.20	$600 \text{ V}_{AC}$ , R = $600 \Omega$ , t = $0.5 \text{ s}$ , without GDT, criteria A
power induction	(no damage, function must be fulfilled)
Enhanced test condition to K.20	230 $V_{AC}$ , t = 15 min., R = 10 1000 Ω, criteria A
power contact	(no damage, function must be fulfilled)

## For type U1154:

GR1089	120 V <sub>AC</sub> (50 Hz), short circuit current 25 A, t = 15 min,
Second level intra building AC	criteria A (no damage, function must be fulfilled)
power fault	
Enhanced test condition to GR1089	$V_{c(max)} = \pm 2.25$ kV (each polarity 1 application), t = 2/10 µs,
first level intra building lightning	$R_G = 2 \Omega$ , $R = 12 \Omega$ , criteria A
surge for multi-pair ports	(no damage, function must be fulfilled)



#### Leaded disks

### Cautions and warnings

### General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

### Storage

- Store thermistors only in original packaging. Do not open the package prior to processing.
- Storage conditions in original packaging: storage temperature −25 °C ... +45 °C, relative humidity ≤75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
  - Through-hole devices (housed and leaded PTCs): 24 months
  - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
  - Telecom pair and quattro protectors (TPP, TQP): 24 months
  - Leadless PTC thermistors for pressure contacting: 12 months
  - Leadless PTC thermistors for soldering: 6 months
  - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
  - SMDs in EIA sizes 1210 and smaller: 12 months

### Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- The ceramic and metallization of the components must not be touched with bare hands. Gloves are recommended
- Avoid contamination of thermistor surface during handling.

### Soldering (where applicable)

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.



#### Leaded disks

### Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force and pressure of the clamping contacts pressing against the PTC must be 10 N and 50 kPa, respectively. In case the assembly is exposed to mechanical shock and/ or vibration this force should be higher in order to avoid movement of the PTC during operation.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

### Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).

This listing does not claim to be complete, but merely reflects the experience of EPCOS AG.

### Display of ordering codes for EPCOS products

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## Leaded disks

# Symbols and terms

Symbol	Term
A	Area
С	Capacitance
$C_{th}$	Heat capacity
f	Frequency
1	Current
I <sub>max</sub>	Maximum current
$I_{R}$	Rated current
I <sub>res</sub>	Residual current
I <sub>PTC</sub>	PTC current
$I_r$	Residual currrent
$I_{r,oil}$	Residual currrent in oil (for level sensors)
$I_{r,air}$	Residual currrent in air (for level sensors)
I <sub>RMS</sub>	Root-mean-square value of current
Is	Switching current
I <sub>Smax</sub>	Maximum switching current
LCT	Lower category temperature
N	Number (integer)
$N_c$	Operating cycles at V <sub>max</sub> , charging of capacitor
$N_{f}$	Switching cycles at V <sub>max</sub> , failure mode
Р	Power
P <sub>25</sub>	Maximum power at 25 °C
$P_{el}$	Electrical power
$P_{diss}$	Dissipation power
$R_{G}$	Generator internal resistance
$R_{\text{min}}$	Minimum resistance
$R_R$	Rated resistance @ rated temperature T <sub>R</sub>
$\Delta R_R$	Tolerance of R <sub>R</sub>
$R_P$	Parallel resistance
$R_{PTC}$	PTC resistance
$R_{ref}$	Reference resistance
$R_s$	Series resistance
R <sub>25</sub>	Resistance at 25 °C
R <sub>25,match</sub>	Resistance matching per reel/ packing unit at 25 °C
$\Delta R_{25}$	Tolerance of R <sub>25</sub>



## Leaded disks

Temperature
Time
Ambient temperature
Thermal threshold time
Ferroelectric Curie temperature
Settling time (for level sensors)
Rated temperature @ 25 °C or otherwise specified in the data sheet
Sensing temperature
Operating temperature
PTC temperature
Response time
Reference temperature
Temperature at minimum resistance
Switching time
Surface temperature
Upper category temperature
Voltage (with subscript only for distinction from volume)
Maximum DC charge voltage of the surge generator
Maximum voltage applied at fault conditions in protection mode
Root-mean-square value of voltage
Breakdown voltage
Insulation test voltage
Maximum link voltage
Maximum operating voltage
Maximum dynamic (short-time) operating voltage
Measuring voltage
Maximum measuring voltage
Rated voltage
Voltage drop across a PTC thermistor
Temperature coefficient
Tolerance, change
Dissipation factor
Thermal cooling time constant

Failure rate

Lead spacing (in mm)

λ •



### Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
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### Important notes

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